

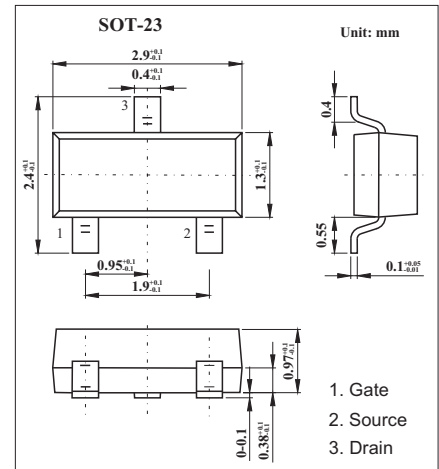
## SOT-23 Plastic-Encapsulate MOSFETS

### Features

- TrenchFET Power MOSFET
- 100% Rg Tested
- N-Channel 30-V (D-S) MOSFET

### MECHANICAL DATA

- Case style:SOT-23molded plastic
- Mounting position:any



## MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-source voltage	V <sub>DS</sub>	30	V
Gate-source voltage	V <sub>GS</sub>	± 20	V
Continuous drain current (T <sub>J</sub> = 150°C) *1,2 T <sub>A</sub> =25 °C T <sub>A</sub> =70°C	I <sub>D</sub>	3.5 2.8	A
Pulsed drain current	I <sub>DM</sub>	16	A
Continuous source current (diode conduction) *1,2	I <sub>S</sub>	1.25	A
Maximum Power dissipation *1,2	P <sub>D</sub>	1.25 0.8	W
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C
Maximum Junction to Ambient Steady State	R <sub>thJA</sub>	100 130	°C/W

\*1 Surface Mounted on FR4 Board.

\*2 t ≤ 5 sec

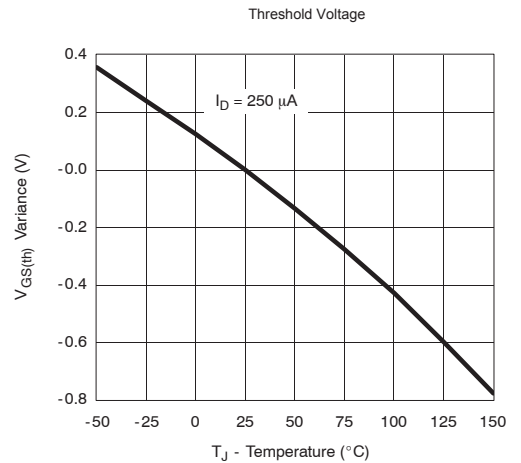
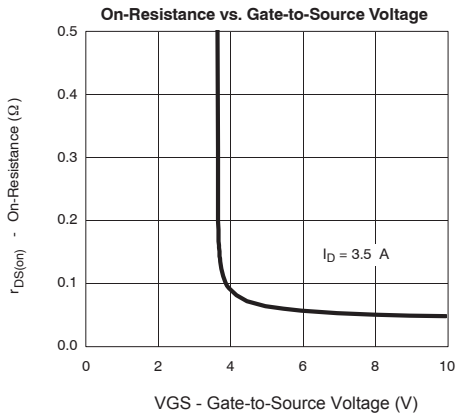
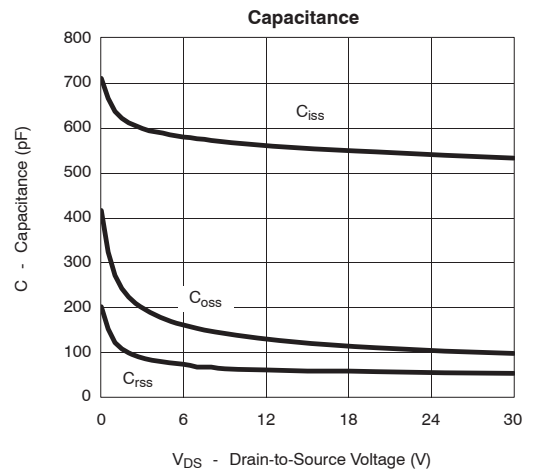
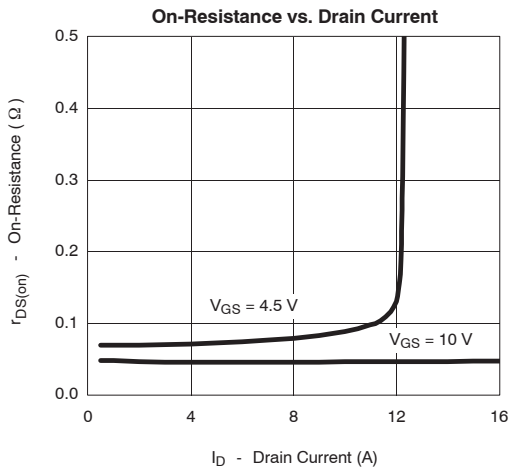
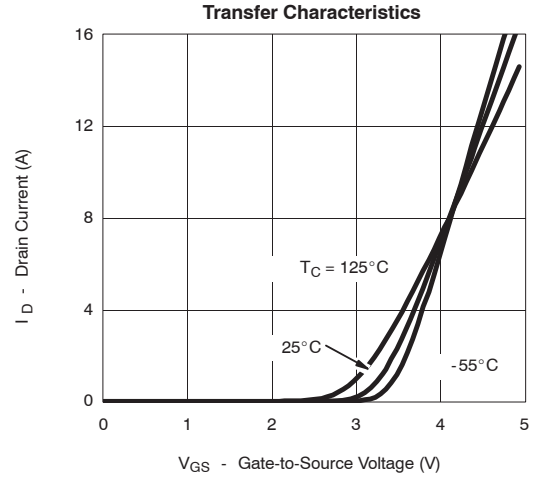
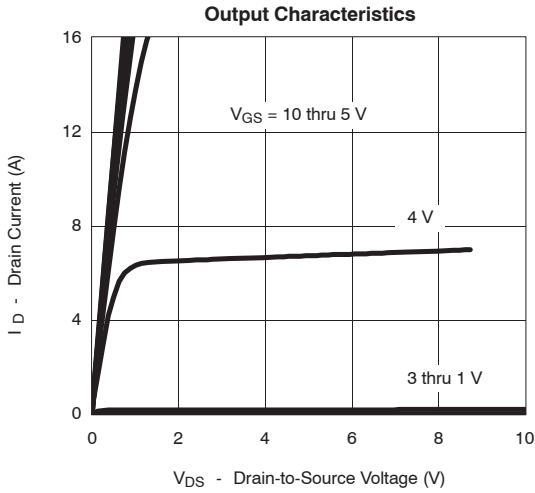
## MOSFET ELECTRICAL CHARACTERISTICS Ta=25 °C unless otherwise specified

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V , I <sub>D</sub> = 250 μA	30			V
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1			
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V , V <sub>GS</sub> = ± 20 V			± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30V , V <sub>GS</sub> = 0 V V <sub>DS</sub> = 30V , V <sub>GS</sub> = 0 V , T <sub>J</sub> = 55 °C			0.5 10	μA
On-state drain current	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 4.5 V , V <sub>GS</sub> = 1.0 V V <sub>DS</sub> ≥ 4.5 V , V <sub>GS</sub> = 4.5 V	6 4			A
Drain-source on-state resistance	r <sub>DS(on)</sub>	V <sub>GS</sub> = 1.0 V , I <sub>D</sub> = 3.5 A V <sub>GS</sub> = 4.5 V , I <sub>D</sub> = 2.8 A		0.046 0.070	0.057 0.094	Ω
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub> = 4.5 V , I <sub>D</sub> = 3.5 A		6.9		S
Diode forward voltage	V <sub>SD</sub>	I <sub>S</sub> = 1.25 A , V <sub>GS</sub> = 0 V		0.8	1.2	V
gate charge *	Q <sub>g</sub>	V <sub>DS</sub> = 15V , V <sub>GS</sub> = 5V , I <sub>D</sub> = 3.5 A		4.2	7	nC
Total gate charge *	Q <sub>gt</sub>	V <sub>DS</sub> = 15V , V <sub>GS</sub> = 1.0 V , I <sub>D</sub> = 3.5 A		8.5	20	nC
Gate-source charge *	Q <sub>gs</sub>			1.9		
Gate-drain charge *	Q <sub>gd</sub>			1.35		
Gate Resistance	R <sub>g</sub>		0.5		2.4	Ω
Input capacitance *	C <sub>iss</sub>	V <sub>DS</sub> = 15V , V <sub>GS</sub> = 0 , f = 1 M H z		555		pF
Output capacitance *	C <sub>oss</sub>			120		
Reverse transfer capacitance *	C <sub>rss</sub>			60		
Turn-on time	t <sub>d(on)</sub> t <sub>r</sub>	V <sub>DD</sub> = 1.5 V , R <sub>L</sub> = 15Ω , I <sub>D</sub> = 1 A , V <sub>GEN</sub> = -10V , R <sub>G</sub> = 6 Ω		9 7.5	02 18	ns
Turn-off time	t <sub>d(off)</sub>			17	35	
	t <sub>f</sub>			5.2	12	

\* Pulse test : P W ≤ 300 μs duty cycle ≤ 2%.

## RATINGS AND CHARACTERISTIC CURVES

### Typical Characteristics



## RATINGS AND CHARACTERISTIC CURVES

